

DS36954

DS36954 Quad Differential Bus Transceiver



Literature Number: SNLS077B

DS36954

Quad Differential Bus Transceiver

General Description

The DS36954 is a low power, quad EIA-485 differential bus transceiver especially suited for high speed, parallel, multi-point, I/O bus applications. A compact 20-pin surface mount PLCC or SOIC package provides high transceiver integration and a very small PC board footprint.

Propagation delay skew between devices is specified to aid in parallel interface designs—limits on maximum and minimum delay times are guaranteed.

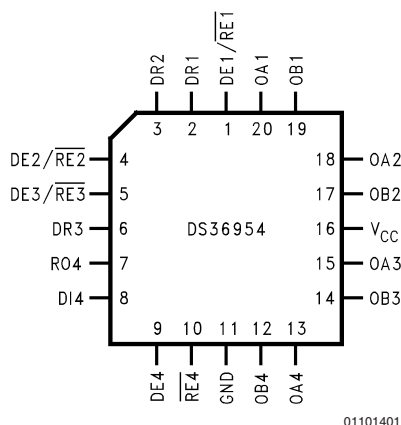
Five devices can implement a complete SCSI initiator or target interface. Three transceivers in a package are pinned

out for data bus connections. The fourth transceiver, with the flexibility provided by its individual enables, can serve as a control bus transceiver.

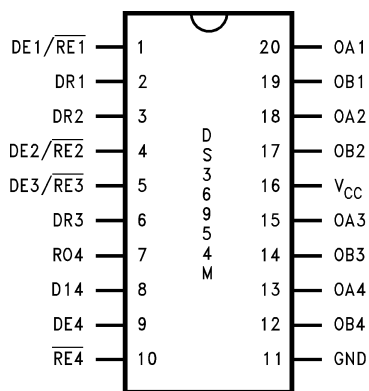
Features

- Pinout for SCSI interface
- Compact 20-pin PLCC or SOIC package
- Meets EIA-485 standard for multipoint bus transmission
- Greater than 60 mA source/sink currents
- Thermal shutdown protection
- Glitch-free driver outputs on power up and down

Connection Diagrams

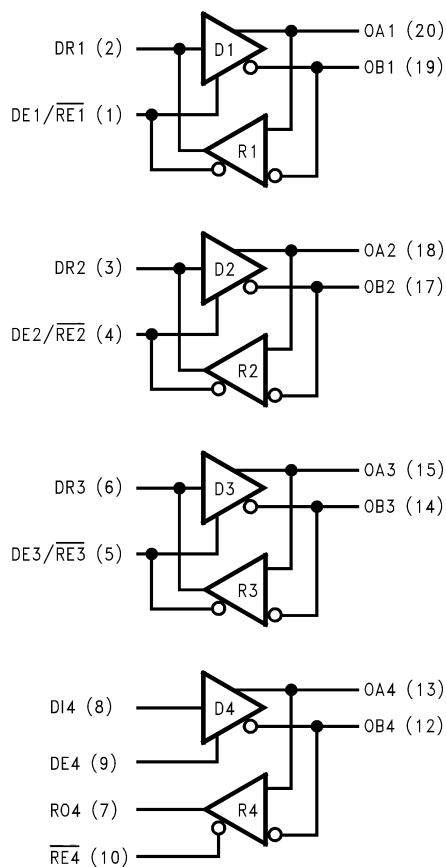


Order Number DS36954V
See NS Package Number V20A



Order Number DS36954M
See NS Package Number M20B

Logic Diagram



01101402

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Control Input Voltage	$V_{CC} + 0.5V$
Driver Input Voltage	$V_{CC} + 0.5V$
Driver Output Voltage/ Receiver Input Voltage	-10V to +15V
Receiver Output Voltage	5.5V
Continuous Power Dissipation @ +25°C	
V Package	1.73W
M Package	1.73W
Derate V Package	13.9 mW/°C above +25°C

Derate M Package

13.7 mW/°C above +25°C

Storage Temperature Range

-65°C to +150°C

Lead Temperature

(Soldering 4 Sec.)

260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage, V_{CC}	4.75	5.25	V
Bus Voltage	-7	+12	V
Operating Free Air Temperature (T_A)	0	+70	°C

Electrical Characteristics (Note 2)

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
DRIVER CHARACTERISTICS						
V _{ODL}	Differential Driver Output Voltage (Full Load)	I _L = 60 mA V _{CM} = 0V	1.5	1.9		V
V _{OD}	Differential Driver Output Voltage (Termination Load)	R _L = 100Ω (EIA-422)	2.0	2.25		V
		R _L = 54Ω (EIA-485)	1.5	2.0		V
ΔIVODI	Change in Magnitude of Driver Differential Output Voltage for Complementary Output States	R _L = 54 or 100Ω (Note 4) (Figure 1) (EIA-422/485)			0.2	V
V _{OC}	Driver Common Mode Output Voltage (Note 5)	R _L = 54Ω (Figure 1) (EIA-485)			3.0	V
ΔIVOCI	Change in Magnitude of Common Mode Output Voltage	(Note 4) (Figure 1) (EIA-422/485)			0.2	V
V _{OH}	Output Voltage High	I _{OH} = −55 mA	2.7	3.2		V
V _{OL}	Output Voltage Low	I _{OL} = 55 mA		1.4	1.7	V
V _{IH}	Input Voltage High		2.0			V
V _{IL}	Input Voltage Low				0.8	V
V _{CL}	Input Clamp Voltage	I _{CL} = −18 mA			−1.5	V
I _{IH}	Input High Current	V _{IN} = 2.4V (Note 3)			20	μA
I _{IL}	Input Low Current	V _{IN} = 0.4V (Note 3)			−20	μA
I _{OSC}	Driver Short-Circuit Output Current (Note 9)	V _O = −7V (EIA-485)		−130	−250	mA
		V _O = 0V (EIA-422)		−90	−150	mA
		V _O = +12V (EIA-485)		130	250	mA
RECEIVER CHARACTERISTICS						
I _{OSR}	Short Circuit Output Current	V _O = 0V (Note 9)	−15	−28	−75	mA
I _{OZ}	TRI-STATE® Output Current	V _O = 0.4V to 2.4V			20	μA
V _{OH}	Output Voltage High	V _{ID} = 0.2V, I _{OH} = 0.4 mA	2.4	3.0		V
V _{OL}	Output Voltage Low	V _{ID} = −0.2V, I _{OL} = 4 mA		0.35	0.5	V
V _{TH}	Differential Input High Threshold Voltage	V _O = V _{OH} , I _O = −0.4 mA (EIA-422/485)		0.03	0.2	V
V _{TL}	Differential Input Low Threshold Voltage (Note 6)	V _O = V _{OL} , I _O = 4.0 mA (EIA-422/485)	−0.20	−0.03		V
V _{HST}	Hysteresis (Note 7)	V _{CM} = 0V	35	60		mV

Electrical Characteristics (Note 2) (Continued)

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
DRIVER AND RECEIVER CHARACTERISTICS						
V_{IH}	Enable Input Voltage High		2.0			V
V_{IL}	Enable Input Voltage Low				0.8	V
V_{CL}	Enable Input Clamp Voltage	$I_{CL} = -18 \text{ mA}$			-1.5	V
I_{IN}	Line Input Current (Note 8)	Other Input = 0V $DE/\overline{RE} = 0.8V$ $DE4 = 0.8V$	$V_I = +12V$	0.5	1.0	mA
			$V_I = -7V$	-0.45	-0.8	mA
I_{ING}	Line Input Current (Note 8)	Other Input = 0V $DE/\overline{RE}$ and $DE4 = 2V$ $V_{CC} = 3.0V$ $T_A = +25^\circ C$	$V_I = +12V$		1.0	mA
			$V_I = -7V$		-0.8	mA
I_{IH}	Enable Input Current High	$V_{IN} = 2.4V$ $DE/\overline{RE}$	$V_{CC} = 3.0V$	1	40	μA
			$V_{CC} = 4.75V$	1		μA
			$V_{CC} = 5.25V$	1	40	μA
		$V_{IN} = 2.4V$ $DE4$ or $\overline{RE4}$	$V_{CC} = 3.0V$	1	20	μA
I_{IL}	Enable Input Current Low	$V_{IN} = 0.8V$ $DE/\overline{RE}$	$V_{CC} = 3.0V$	-6	-40	μA
			$V_{CC} = 4.75V$	-12		μA
			$V_{CC} = 5.25V$	-14	-40	μA
		$V_{IN} = 0.8V$ $DE4$ or $\overline{RE4}$	$V_{CC} = 3.0V$	-3	-20	μA
			$V_{CC} = 5.25V$	-7	-20	μA
I_{CCD}	Supply Current (Note 10)	No Load, $DE/\overline{RE}$ and $DE4 = 2.0V$		75	90	mA
I_{CCR}	Supply Current (Note 10)	No Load, $DE/\overline{RE}$ and $\overline{RE4} = 0.8V$		50	70	mA

Switching Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Units
DRIVER SINGLE-ENDED CHARACTERISTICS							
t _{PZH}	Output Enable Time to High Level	R _L = 110Ω	(Figure 5)		35	40	ns
t _{PZL}	Output Enable Time to Low Level		(Figure 6)		25	40	ns
t _{PHZ}	Output Disable Time to High Level		(Figure 5)		15	25	ns
t _{PLZ}	Output Disable Time to Low Level		(Figure 6)		35	40	ns
DRIVER DIFFERENTIAL CHARACTERISTICS							
t _r , t _f	Rise and Fall Time	R _L = 54Ω C _L = 50 pF C _D = 15 pF (Figures 3, 4, 9)			13	16	ns
t _{PLHD}	Differential Propagation			9	15	19	ns
t _{PHLD}	Delays (Note 15)			9	12	19	ns
t _{SKD}	t _{PLHD} – t _{PHLD} Diff. Skew				3	6	ns
RECEIVER CHARACTERISTICS							
t _{PLHD}	Differential Propagation Delays	C _L = 15 pF V _{CM} = 2.0V (Figure 7)		9	14	19	ns
t _{PHLD}				9	13	19	ns
t _{SKD}	t _{PLHD} – t _{PHLD} Diff. Receiver Skew				1	3	ns
t _{PZH}	Output Enable Time to High Level	C _L = 15 pF (Figure 8)			15	22	ns
t _{PZL}	Output Enable Time to Low Level				20	30	ns
t _{PHZ}	Output Disable Time from High Level				20	30	ns
t _{PLZ}	Output Disable Time from Low Level				17	25	ns

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

Note 2: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground unless otherwise specified.

Switching Characteristics (Continued)

Note 3: I_{IH} and I_{IL} include driver input current and receiver TRI-STATE leakage current on DR(1–3).

Note 4: $\Delta IVODI$ and $\Delta IVOCI$ are changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input changes state.

Note 5: In EIA Standards EIA-422 and EIA-485, V_{OC} , which is the average of the two output voltages with respect to ground, is called output offset voltage, V_{OS} .

Note 6: Threshold parameter limits specified as an algebraic value rather than by magnitude.

Note 7: Hysteresis defined as $V_{HST} = V_{TH} - V_{TL}$.

Note 8: I_{IN} includes the receiver input current and driver TRI-STATE leakage current.

Note 9: Short one output at a time.

Note 10: Total package supply current.

Note 11: All typicals are given for $V_{CC} = 5.0V$ and $T_A = +25^\circ C$.

Parameter Measurement Information

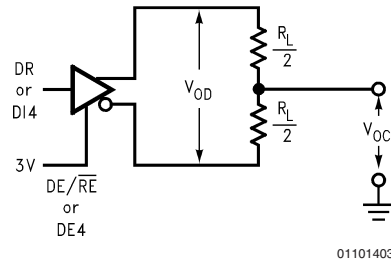


FIGURE 1. Driver V_{OD} and V_{OC} (Note 13)

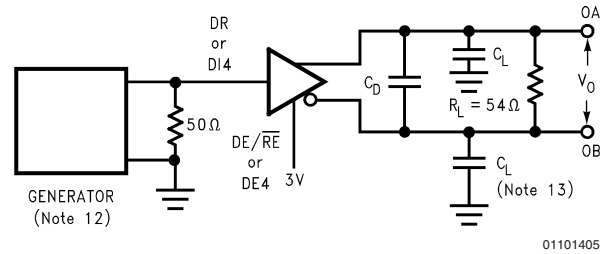


FIGURE 3. Driver Differential Propagation Delay Load Circuit

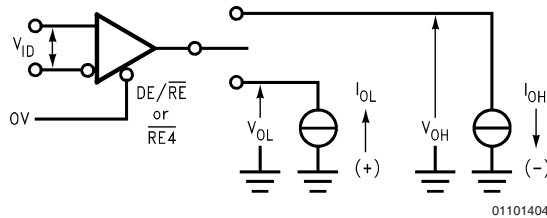


FIGURE 2. Receiver V_{OH} and V_{OL}

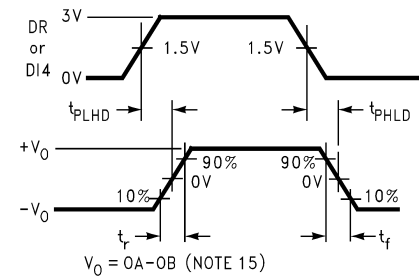
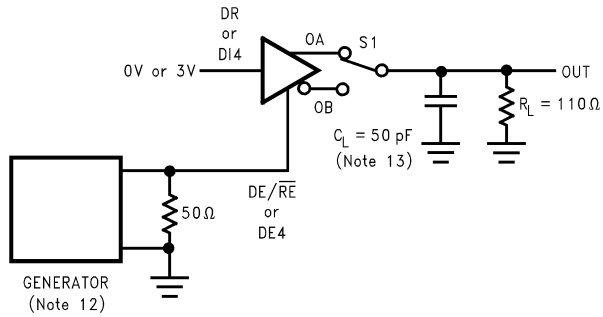


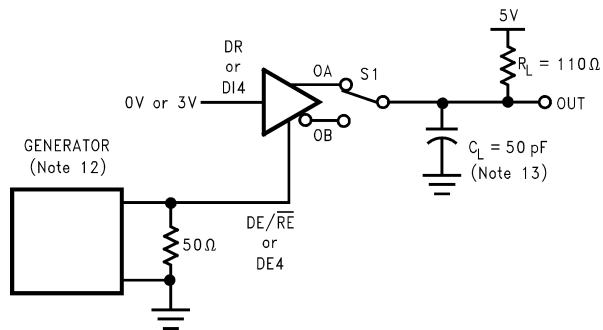
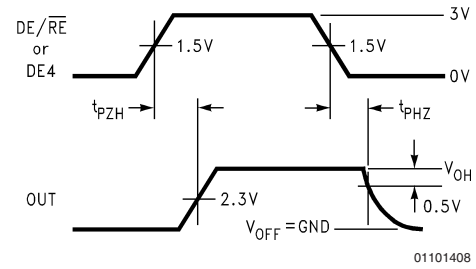
FIGURE 4. Driver Differential Propagation Delays and Transition Times

Parameter Measurement Information (Continued)



S1 to OA for DI = 3V
S1 to OB for DI = 0V

FIGURE 5. Driver Enable and Disable Timing (t_{PZH} , t_{PHZ})



S1 to OA for DI = 0V
S1 to OB for DI = 3V

FIGURE 6. Driver Enable and Disable Timing (t_{PZL} , t_{PLZ})

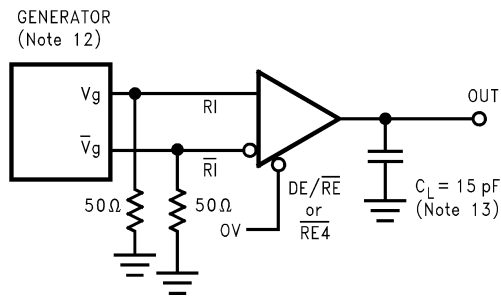
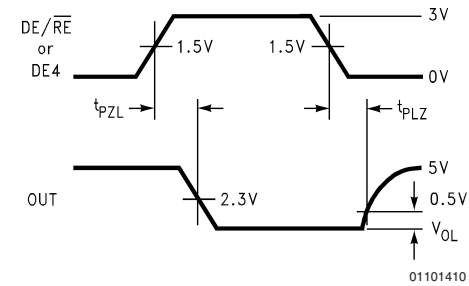
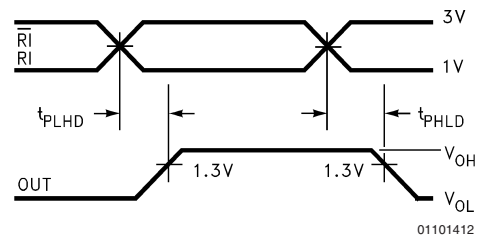


FIGURE 7. Receiver Differential Propagation Delay Timing



Parameter Measurement Information (Continued)

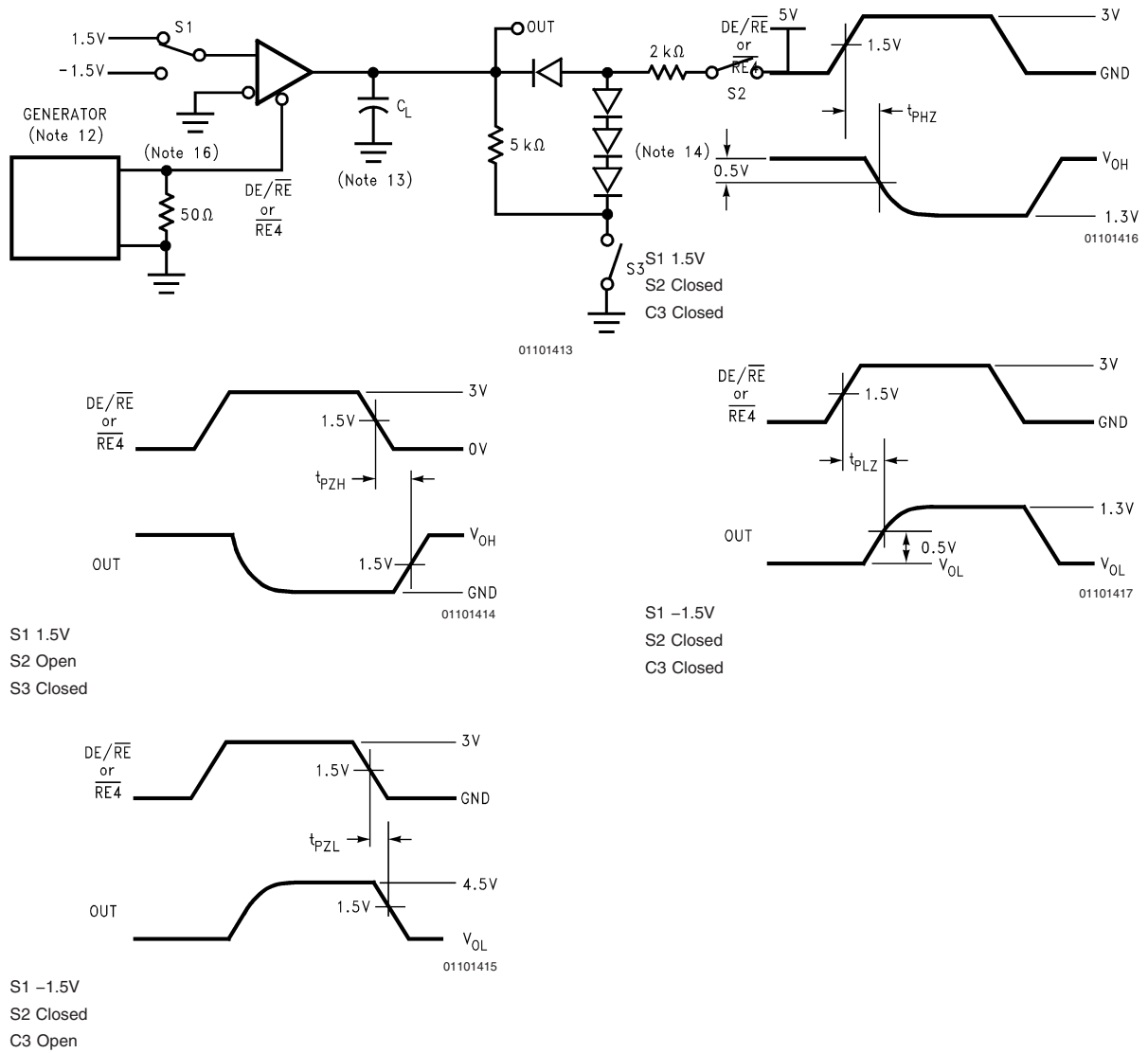
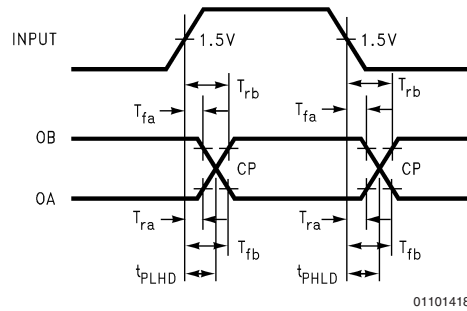


FIGURE 8. Receiver Enable and Disable Timing

Parameter Measurement Information (Continued)



$$T_{CP} = \frac{(T_{fb} \times T_{rb}) - (T_{ra} \times T_{fa})}{T_{rb} - T_{ra} - T_{fa} + T_{fb}}$$

T_{ra} , T_{rb} , T_{fa} and T_{fb} are propagation delay measurements to the 20% and 80% levels.

T_{CP} = Crossing Point

FIGURE 9. Propagation Delay Timing for Calculations of Driver Differential Propagation Delays

Note 12: The input pulse is supplied by a generator having the following characteristics: $f = 1.0$ MHz, 50% duty cycle, t_r and $t_f < 6.0$ ns, $Z_0 = 50\Omega$.

Note 13: C_L includes probe and stray capacitance.

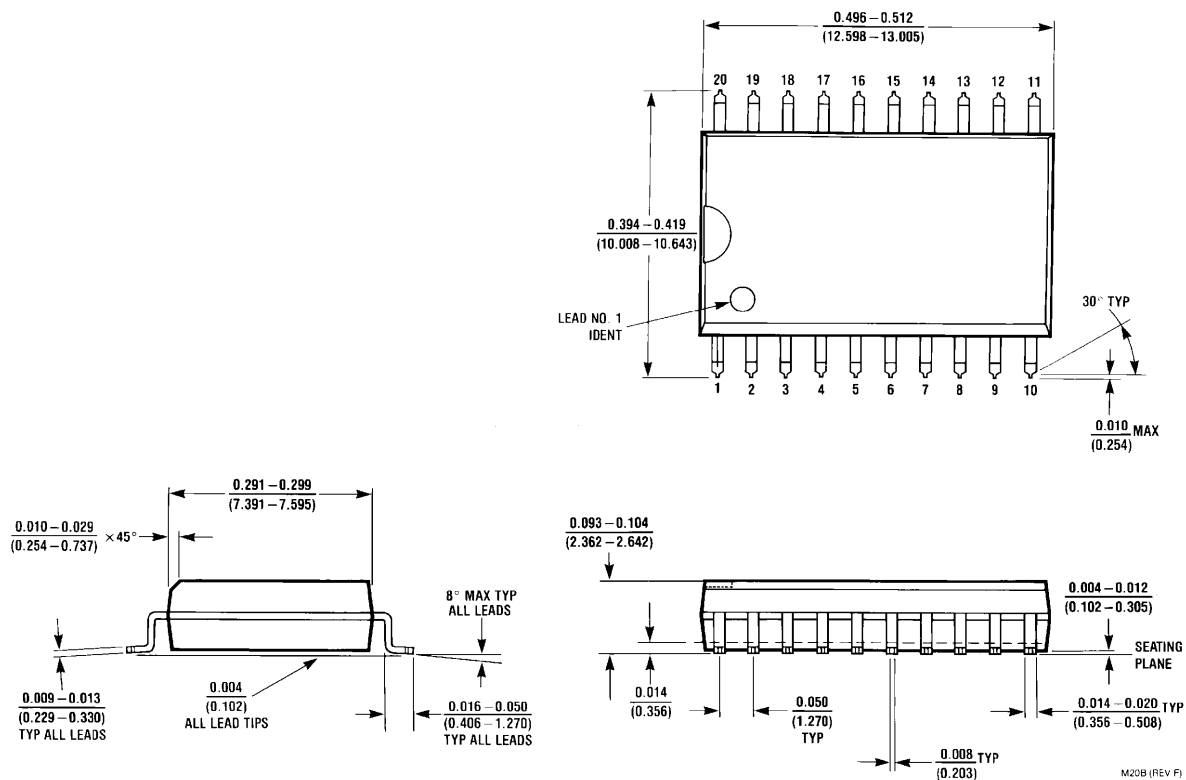
Note 14: Diodes are 1N916 or equivalent.

Note 15: Differential propagation delays are calculated from single-ended propagation delays measured from driver input to the 20% and 80% levels on the driver outputs (Figure 9).

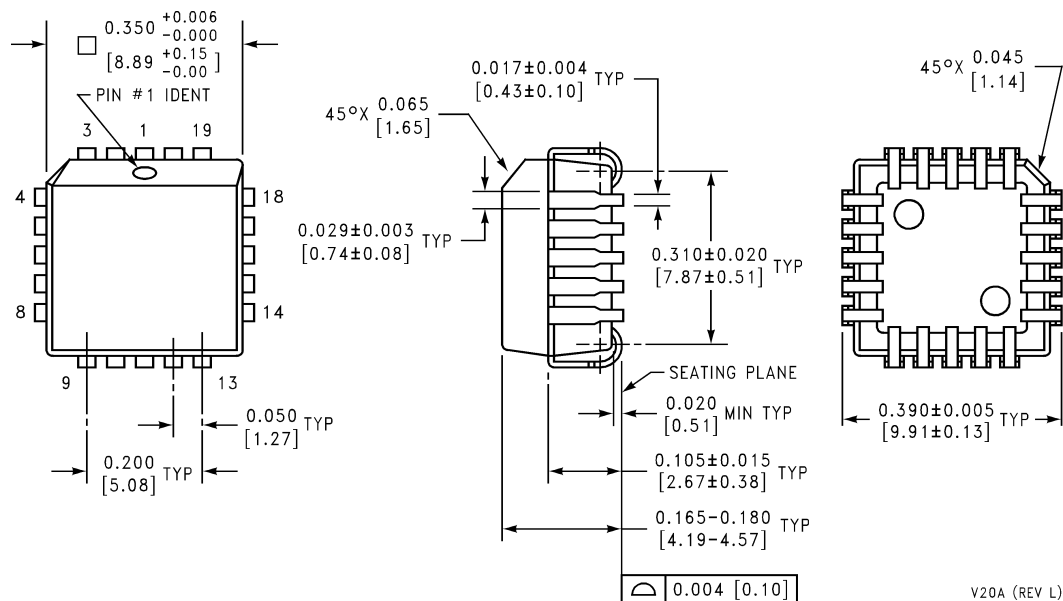
Note 16: On transceivers 1–3 the driver is loaded with receiver input conditions when $DE/\overline{RE}$ is high. Do not exceed the package power dissipation limit when testing.

Physical Dimensions inches (millimeters)

unless otherwise noted



Order Number DS36954M
NS Package Number M20B



Order Number DS36954V
NS Package Number V20A

Notes

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